

## HIGH VOLTAGE POWER SCHOTTKY RECTIFIER

**Table 1: Main Product Characteristics**

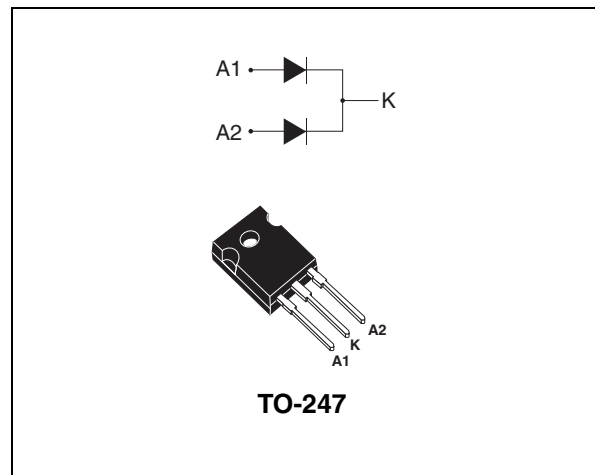
$I_{F(AV)}$	2 x 30 A
$V_{RRM}$	170 V
$T_j$	175 °C
$V_F(max)$	0.67 V

**FEATURES AND BENEFITS**

- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Low thermal resistance
- High frequency operation
- Avalanche specification

**DESCRIPTION**

Dual center tab Schottky rectifier suited for High Frequency Switch Mode Power Supply. Packaged in TO-247, this device is intended for use to enhance the reliability of the application.



**Table 2: Order Code**

Part Number	Marking
STPS61170CW	STPS61170CW

**Table 3: Absolute Ratings** (limiting values, per diode)

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		170	V
$I_{F(RMS)}$	RMS forward current		80	A
$I_{F(AV)}$	Average forward current	$T_c = 150\text{ °C}$ $\delta = 0.5$	Per diode 60	A
$I_{FSM}$	Surge non repetitive forward current		$t_p = 10\text{ ms sinusoidal}$	500 A
$P_{ARM}$	Repetitive peak avalanche power		$t_p = 1\text{ }\mu\text{s}$ $T_j = 25\text{ °C}$	31800 W
$T_{stg}$	Storage temperature range		-65 to + 175	°C
$T_j$	Maximum operating junction temperature *		175	°C
dV/dt	Critical rate of rise of reverse voltage		10000	V/ $\mu\text{s}$

\* :  $\frac{dP_{tot}}{dT_j} > \frac{1}{R_{th(j-a)}}$  thermal runaway condition for a diode on its own heatsink

**Table 4: Thermal Parameters**

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case	Per diode	0.9
		Total	0.6
$R_{th(c)}$	Coupling	0.3	

When the diodes 1 and 2 are used simultaneously:  
 $\Delta T_j(\text{diode } 1) = P(\text{diode } 1) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode } 2) \times R_{th(c)}$

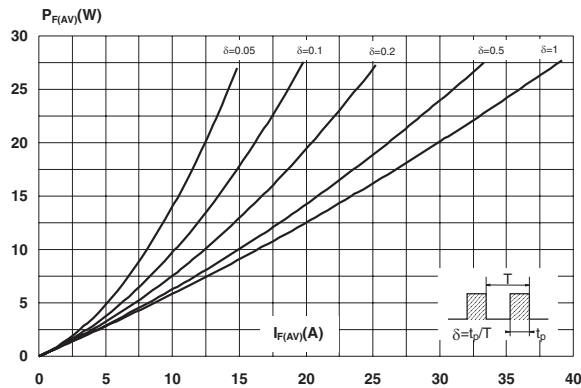
**Table 5: Static Electrical Characteristics (per diode)**

Symbol	Parameter	Tests conditions	Min.	Typ	Max.	Unit
$I_R^*$	Reverse leakage current	$T_j = 25^\circ\text{C}$			60	$\mu\text{A}$
		$T_j = 125^\circ\text{C}$	$V_R = V_{RRM}$	16	60	mA
$V_F^{**}$	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 30\text{ A}$		0.84	V
		$T_j = 125^\circ\text{C}$	$I_F = 30\text{ A}$	0.63	0.67	
		$T_j = 25^\circ\text{C}$	$I_F = 60\text{ A}$		0.92	
		$T_j = 125^\circ\text{C}$	$I_F = 60\text{ A}$	0.76	0.80	

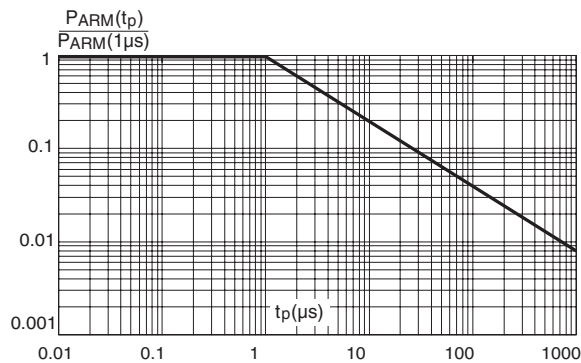
Pulse test: \*  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$   
 \*\*  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

To evaluate the conduction losses use the following equation:  $P = 0.54 \times I_{F(AV)} + 0.0043 I_{F(RMS)}^2$

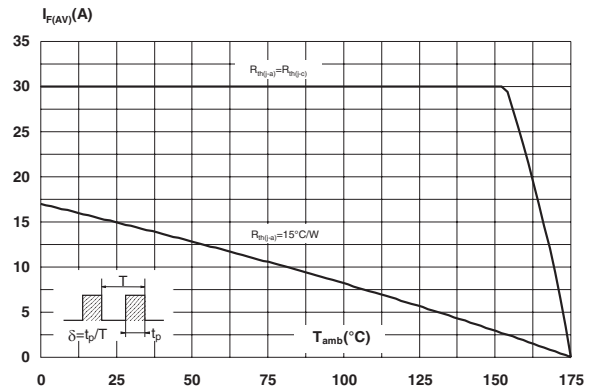
**Figure 1: Average forward power dissipation versus average forward current (per diode)**



**Figure 3: Normalized avalanche power derating versus pulse duration**



**Figure 2: Average forward current versus ambient temperature (delta = 0.5, per diode)**



**Figure 4: Normalized avalanche power derating versus junction temperature**

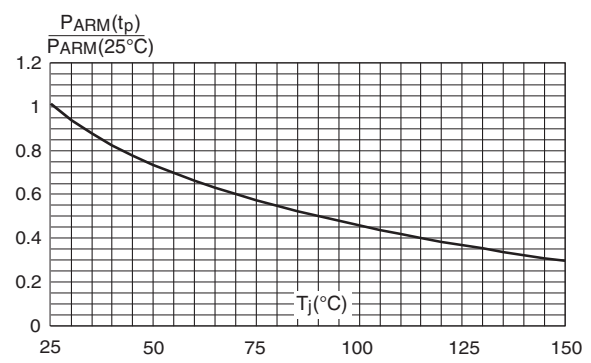


Figure 5: Non repetitive surge peak forward current versus overload duration (maximum values, per diode)

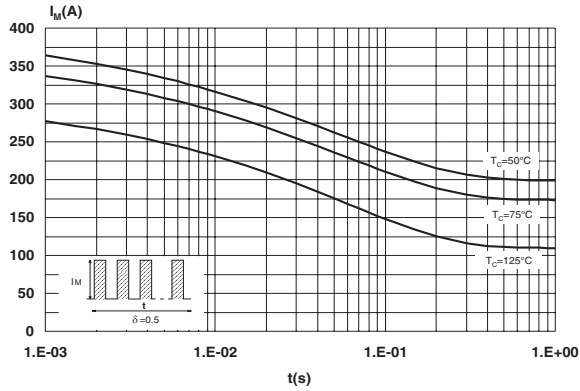


Figure 6: Relative variation of thermal impedance junction to case versus pulse duration (per diode)

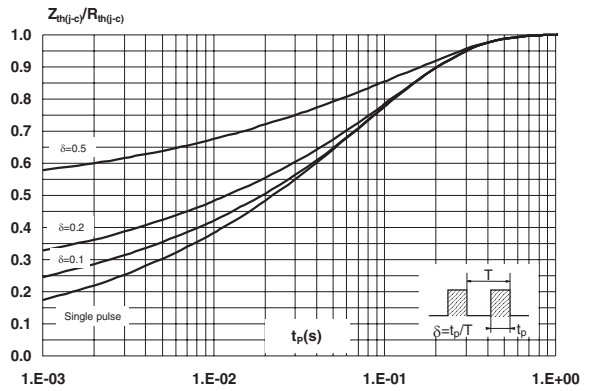


Figure 7: Reverse leakage current versus reverse voltage applied (typical values, per diode)

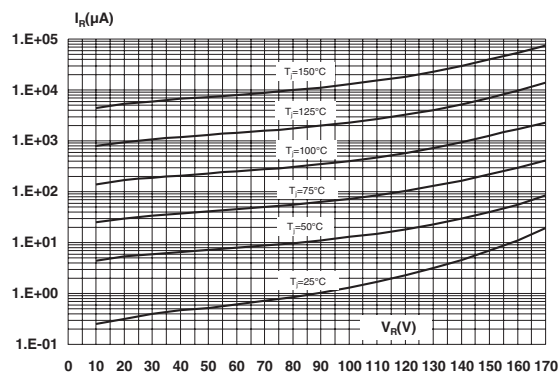


Figure 8: Junction capacitance versus reverse voltage applied (typical values, per diode)

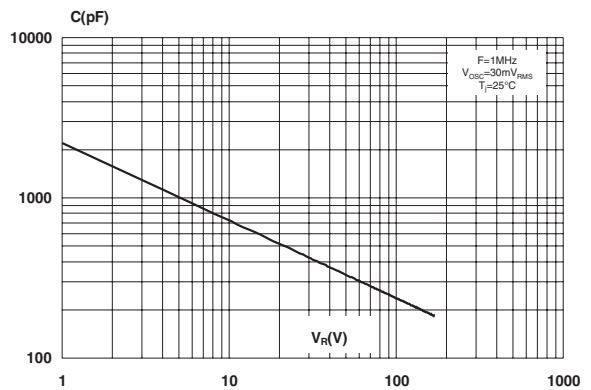


Figure 9: Forward voltage drop versus forward current (per diode, low level)

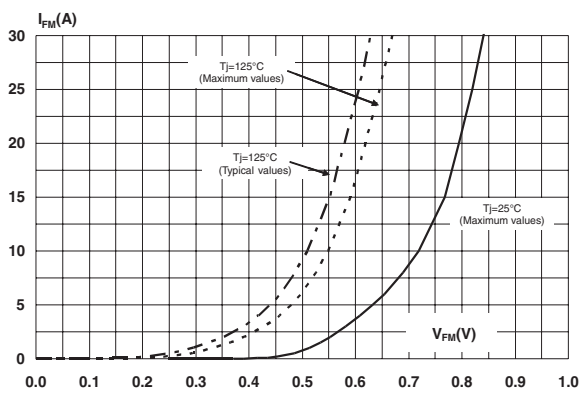


Figure 10: Forward voltage drop versus forward current (per diode, high level)

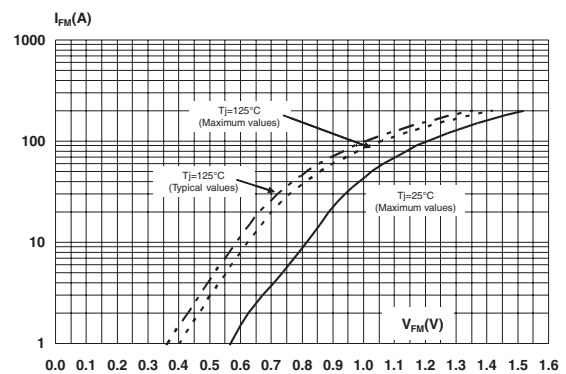
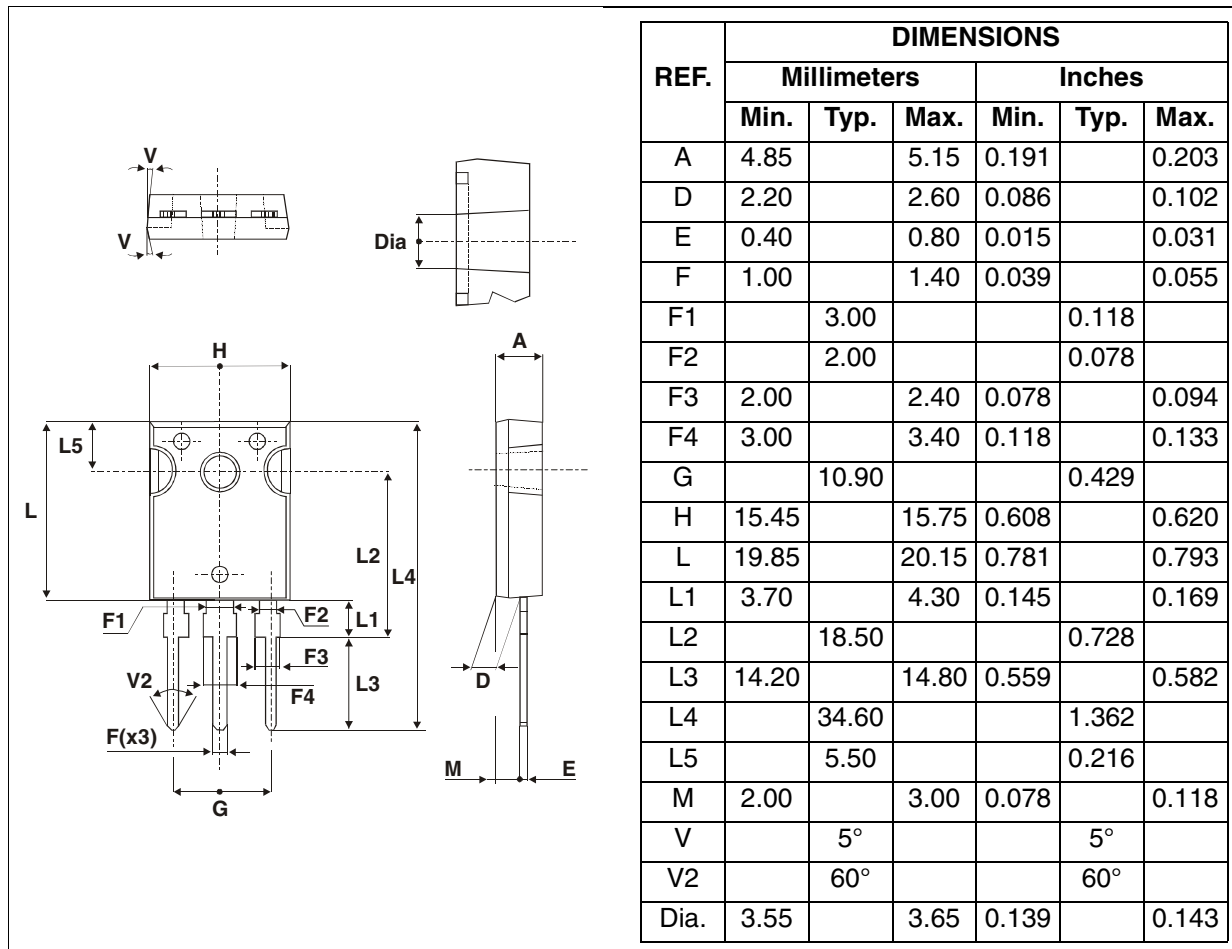


Figure 11: TO-247 Package Mechanical Data



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

Table 6: Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS61170CW	STPS61170CW	TO-247	4.40 g	30	Tube

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 Nm.
- Maximum torque value: 1.0 Nm.

Table 7: Revision History

Date	Revision	Description of Changes
16-Sep-2005	1	First issue.

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